

36100-01-0103
10/01/03
11/06/01

P

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10013103	FILING DATE 11/06/2001	CLASS 257 438	SUBCLASS 640	CAU 2822	EXAMINER LeDrie
----------------------	---------------------------	---------------------	-----------------	-------------	--------------------

**APPLICANT'S: Seshan Krishna; Dass M.; Bakker Geoffrey;

**CONTINUING DATA VERIFIED:
THIS APPLICATION IS A DIV OF 09/105,590 06/26/1998

**FOREIGN APPLICATIONS VERIFIED:

PG-PUB <input type="checkbox"/>	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO 42390P5778D
Verified and Acknowledged Examiners's initials		

TITLE : Semiconductor passivation deposition process for interfacial adhesion
U.S. DEPT. OF COMM/PAT. & TM-PTO-435L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
ISSUE FEE'S		Assistant Examiner	
Amount Due	Date Paid	Primary Examiner	
TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
		Application Examiner	
WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.			
FILED WITH:		<input type="checkbox"/> DISK (CRF) <input type="checkbox"/> CD-ROM (Attached in pocket on right inside flap)	